COATING METALLIC MATERIAL; COATING MATERIAL WITH METALLIC MATERIAL \(\text{(by metallising textiles D06M 11/83; decorating textiles by locally metallising D06Q 1/04; CHEMICAL SURFACE TREATMENT; DIFFUSION TREATMENT OF METALLIC MATERIAL; COATING BY VACUUM EVAPORATION, BY SPUTTERING, BY ION IMPLANTATION OR BY CHEMICAL VAPOUR DEPOSITION, IN GENERAL)}\) (for specific applications, see the relevant places, e.g. for manufacturing resistors H01C 17/06); INHIBITING CORROSION OF METALLIC MATERIAL OR INCRUSTATION IN GENERAL \(\text{(treating metal surfaces or coating of metals by electrolysis or electrophoresis C25D, C25F)}\) \[2\]

Note

In this class, the following expression is used with the meaning indicated:
- “metallic material” covers:
  (a) metals; \[4\]
  (b) alloys (attention is drawn to the Note following the title of subclass C22C).

COATING METALLIC MATERIAL; COATING MATERIAL WITH METALLIC MATERIAL; SURFACE TREATMENT OF METALLIC MATERIAL BY DIFFUSION INTO THE SURFACE, BY CHEMICAL CONVERSION OR SUBSTITUTION; COATING BY VACUUM EVAPORATION, BY SPUTTERING, BY ION IMPLANTATION OR BY CHEMICAL VAPOUR DEPOSITION, IN GENERAL \(\text{(applying liquids or other fluent materials to surfaces in general B05; making metal-coated products by extrusion B21C 23/22; covering with metal by connecting pre-existing layers to articles, see the relevant places, e.g. B21D 39/00, B23K; working of metal by the action of a high concentration of electric current on a workpiece using an electrode B23H; metallising of glass C03C; metallising mortars, concrete, artificial stone, ceramics or natural stone C04B 41/00; paints, varnishes, laquers C09D; enamelling of, or applying a vitreous layer to, metals C23D; inhibiting corrosion of metallic material or incrustation in general C23E; single-crystal film growth C30B; details of scanning-probe apparatus, in general G05D 5/02; manufacture of semiconductor devices H01L; manufacture of printed circuits H05K)}\) \[4\]

Note

In this subclass, an operation is considered as pretreatment or after-treatment when it is specially adapted for, but quite distinct from, the coating process concerned and constitutes an independent operation. If an operation results in the formation of a permanent sub- or upper layer, it is not considered as pretreatment or after-treatment and is classified as a multi-coating process. \[4\]

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Int.CI. (2006.01), Section C
Solid state diffusion of only non-metal elements into metallic material surfaces [4]

8/00 Solid state diffusion of only non-metal elements into metallic material surfaces (diffusion of silicon C23C 10/00); Chemical surface treatment of metallic material by reaction of the surface with a reactive gas, leaving reaction products of surface material in the coating, e.g. conversion coatings, passivation of metals (C23C 14/00 takes precedence) [4]

8/02. Pretreatment of the material to be coated (C23C 8/04 takes precedence) [4]
8/04. Treatment of selected surface areas, e.g. using masks [4]
8/06. using gases [4]
8/08. only one element being applied [4]
8/12. using elemental oxygen or ozone [4]
8/16. using oxygen-containing compounds, e.g. \( \text{H}_2\text{O}, \text{CO}_2 \) [4]
8/22. of ferrous surfaces [4]
8/26. of ferrous surfaces [4]
8/28. more than one element being applied in one step [4]
8/32. of ferrous surfaces [4]
8/34. more than one element being applied in more than one step [4]
8/36. using ionised gases, e.g. ionitriding (discharge tubes with provision for introducing objects or material to be exposed to the discharge H01J 37/00) [4]
8/40. using liquids, e.g. salt baths, liquid suspensions [4]
8/42. only one element being applied [4]
8/44. Carburising [4]
8/46. of ferrous surfaces [4]
8/50. of ferrous surfaces [4]
8/52. more than one element being applied in one step [4]
8/56. of ferrous surfaces [4]

8/58. more than one element being applied in more than one step [4]
8/60. using solids, e.g. powders, pastes (using liquid suspensions of solids C23C 8/40) [4]
8/62. only one element being applied [4]
8/64. Carburising [4]
8/66. of ferrous surfaces [4]
8/70. of ferrous surfaces [4]
8/72. more than one element being applied in one step [4]
8/76. of ferrous surfaces [4]
8/78. more than one element being applied in more than one step [4]
Coating by vacuum evaporation, by sputtering or by ion implantation [4]

14/00 Coating by vacuum evaporation, by sputtering or by ion implantation of the coating forming material (discharge tubes with provision for introducing objects or material to be exposed to the discharge [4]

14/02 Pretreatment of the material to be coated (C23C 14/04 takes precedence) [4]

14/04 Coating on selected surface areas, e.g. using masks [4]

14/06 characterised by the coating material (C23C 14/04 takes precedence) [4]

14/08 Oxides (C23C 14/10 takes precedence) [4]

14/10 Glass or silica [4]

14/12 Organic material [4]

14/14 Metallic material, boron or silicon [4]

14/16 on metallic substrates or on substrates of boron or silicon [4]

14/18 on other inorganic substrates [4]

14/20 on organic substrates [4]

14/22 characterised by the process of coating [4]

14/24 Vacuum evaporation [4]

14/26 by resistance or inductive heating of the source [4]

14/28 by wave energy or particle radiation (C23C 14/32 to C23C 14/48 take precedence) [4]

14/30 by electron bombardment [4]

14/32 by explosion; evaporation and subsequent ionisation of the vapours (C23C 14/34 to C23C 14/48 take precedence) [4]

14/34 Sputtering [4]

14/35 by application of a magnetic field, e.g. magnetron sputtering [5]

14/36 Diode sputtering (C23C 14/35 takes precedence) [4,5]

14/38 by direct current glow discharge [4]

14/40 with alternating current discharge, e.g. high-frequency discharge [4]

14/42 Triode sputtering (C23C 14/35 takes precedence) [4,5]

14/44 by application of high frequencies and additional direct voltages [4]

14/46 by ion beam produced by an external ion source (C23C 14/40 takes precedence) [4]

14/48 Ion implantation [4]

14/50 Substrate holders [4]

14/52 Means for observation of the coating process [4]

14/54 Controlling or regulating the coating process (controlling or regulating in general G05) [4]

14/56 Apparatus specially adapted for continuous coating; Arrangements for maintaining the vacuum, e.g. vacuum locks [4]

14/58 After-treatment [4]

Chemical deposition or plating by decomposition: Contact plating (solid state diffusion C23C 8/00 to C23C 12/00) [4]

16/00 Chemical coating by decomposition of gaseous compounds, without leaving reaction products of surface material in the coating, i.e. chemical vapour deposition (CVD) processes (reactive sputtering or vacuum evaporation C23C 14/00) [4]

16/01 on temporary substrates, e.g. on substrates subsequently removed by etching [7]

16/02 Pretreatment of the material to be coated (C23C 16/04 takes precedence) [4]

16/04 Coating on selected surface areas, e.g. using masks [4]

16/06 characterised by the deposition of metallic material [4]

16/08 from metal halides [4]

16/10 Deposition of chromium only [4]

16/12 Deposition of aluminium only [4]

16/14 Deposition of only one other metal element [4]

16/16 from metal carbonyl compounds [4]

16/18 from metallo-organic compounds [4]

16/20 Deposition of aluminium only [4]

16/22 characterised by the deposition of inorganic material, other than metallic material [4]

16/24 Deposition of silicon only [4]

16/26 Deposition of carbon only [4]

16/27 Diamond only [7]

16/28 Deposition of only one other non-metal element [4]

16/30 Deposition of compounds, mixtures or solid solutions, e.g. borides, carbides, nitrides [4]

16/32 Carbides [4]

16/34 Nitriles [4]

16/36 Carbo-nitrides [4]

16/38 Borides [4]

16/40 Oxides [4]

16/42 Silicides [4]

16/44 characterised by the method of coating (C23C 16/04 takes precedence) [4]

16/442 using fluidised bed processes [7]

16/448 characterised by the method used for generating reactive gas streams, e.g. by evaporation or sublimation of precursor materials [7]

16/452 by activating reactive gas streams before introduction into the reaction chamber, e.g. by ionization or by addition of reactive species [7]

16/453 passing the reaction gases through burners or torches, e.g. atmospheric pressure CVD (C23C 16/513 takes precedence; for flame or plasma spraying of coating material in the molten state C23C 4/00) [7]

16/455 characterised by the method used for introducing gases into the reaction chamber or for modifying gas flows in the reaction chamber [7]

16/458 characterised by the method used for supporting substrates in the reaction chamber [7]

16/46 characterised by the method used for heating the substrate (C23C 16/48, C23C 16/50 take precedence) [4]

16/48 by irradiation, e.g. photolysis, radiolysis, particle radiation [4]

16/50 using electric discharges [4]

16/503 using dc or ac discharges [7]

16/505 using radio frequency discharges [7]
16/07 . . . using external electrodes, e.g. in tunnel type reactors [7]
16/09 . . . using internal electrodes [7]
16/11 . . . using microwave discharges [7]
16/13 . . . using plasma jets [7]
16/15 . . . using pulsed discharges [7]
16/17 . . . using a combination of discharges covered by two or more of groups C23C 16/503 to C23C 16/515 [7]
16/52 . . . Controlling or regulating the coating process (controlling or regulating in general G05) [4]
16/54 . . . Apparatus specially adapted for continuous coating [4]
18/00 Chemical coating by decomposition of either liquid compounds or solutions of the coating forming compounds, without leaving reaction products of surface material in the coating (chemical surface reaction C23C 8/00, C23C 22/00); Contact plating [4]

**Note**

This group covers also suspensions containing reactive liquids and non-reactive solid particles. [4]

18/02 . . . by thermal decomposition [4]
18/04 . . . Pretreatment of the material to be coated (C23C 18/06 takes precedence) [4]
18/06 . . . Coating on selected surface areas, e.g. using masks [4]
18/08 . . . characterised by the deposition of metallic material [4]
18/10 . . . Deposition of aluminium only [4]
18/12 . . . characterised by the deposition of inorganic material other than metallic material [4]
18/14 . . . Decomposition by irradiation, e.g. photolysis, particle radiation [4]
18/16 . . . by reduction or substitution, i.e. electroless plating (C23C 18/54 takes precedence) [4]
18/18 . . . Pretreatment of the material to be coated [4]
18/20 . . . of organic surfaces, e.g. resins [4]
18/22 . . . Roughening, e.g. by etching [4]
18/24 . . . using acid aqueous solutions [4]
18/28 . . . Sensitising or activating [4]
18/31 . . . Coating with metals [5]

18/32 . . . Coating with one of iron, cobalt or nickel; Coating with mixtures of phosphorus or boron with one of these metals [4,5]

18/34 . . . using reducing agents [4,5]
18/36 . . . using hypophosphites [4,5]
18/38 . . . Coating with copper [4,5]
18/40 . . . using reducing agents [4,5]
18/42 . . . Coating with noble metals [4,5]
18/44 . . . using reducing agents [4,5]
18/48 . . . Coating with alloys [4,5]
18/50 . . . with alloys based on iron, cobalt or nickel (C23C 18/32 takes precedence) [4,5]
18/52 . . . using reducing agents for coating with metallic material not provided for in a single one of groups C23C 18/32 to C23C 18/50 [4]
18/54 . . . Contact plating, i.e. electroless electrochemical plating [4]

20/00 Chemical coating by decomposition of either solid compounds or suspensions of the coating forming compounds, without leaving reaction products of surface material in the coating (chemical surface reaction C23C 8/00, C23C 22/00) [4]

**Note**

This group covers also suspensions containing non-reactive liquids and reactive solid particles. [4]

20/02 . . . Coating with metallic material [4]
20/04 . . . with metals [4]
20/06 . . . Coating with inorganic material, other than metallic material [4]
20/08 . . . with compounds, mixtures or solid solutions, e.g. borides, carbides, nitrides [4]

**Chemical surface treatment of metallic material by reaction of the surface with a reactive medium** (with a reactive gas C23C 8/00) [4]

22/00 Chemical surface treatment of metallic material by reaction of the surface with a reactive liquid, leaving reaction products of surface material in the coating, e.g. conversion coatings, passivation of metals (wash primers C09D 5/12) [4]

**Notes**

(1) This group covers also suspensions containing reactive liquids and non-reactive solid particles. [4]

(2) Rejuvenating of the bath is classified in the appropriate place for the specific bath composition. [4]

**Note**

In groups C23C 22/02 to C23C 22/86, in the absence of an indication to the contrary, classification is made in the last appropriate place. [4]

22/02 . . . using non-aqueous solutions [4]
22/03 . . . containing phosphorus compounds [4]
22/04 . . . containing hexavalent chromium compounds [4]
22/05 . . . using aqueous solutions [5]
22/06 . . . using aqueous acidic solutions with pH < 6 [4,5]
22/07 . . . containing phosphates [4,5]
22/08 . . . Orthophosphates [4,5]
22/10 . . . containing oxidants [4,5]
22/12 . . . containing zinc cations [4,5]
22/13 . . . containing also nitrate or nitrite anions [4,5]
22/14 . . . containing also chlorate anions [4,5]
22/16 . . . containing also peroxy-compounds [4,5]
22/17 . . . containing also organic acids [4,5]
22/18 . . . containing manganese cations [4,5]
22/20 . . . containing aluminium cations [4,5]
22/22 . . . containing alkaline earth metal cations [4,5]
22/23 . . . Condensed phosphates [4,5]
22/24 . . . containing hexavalent chromium compounds [4,5]
22/26 . . . containing also organic compounds [4,5]
22/27 . . . Acids [4,5]
22/28 . . . Macromolecular compounds [4,5]
22/30 . . . containing also trivalent chromium [4,5]
**C23D**  
**ENAMELLING OF, OR APPLYING A VITREOUS LAYER TO, METALS** (chemical composition of the enamels C03C)

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<td>containing also phosphates [4,5]</td>
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<tr>
<td>22/34</td>
<td>containing fluorides or complex fluorides [4,5]</td>
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<tr>
<td>22/36</td>
<td>containing also phosphates [4,5]</td>
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<tr>
<td>22/37</td>
<td>containing also hexavalent chromium compounds [4,5]</td>
</tr>
<tr>
<td>22/38</td>
<td>containing also phosphates [4,5]</td>
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<tr>
<td>22/40</td>
<td>containing molybdates, tungstates or vanadates [4,5]</td>
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<tr>
<td>22/42</td>
<td>containing also phosphates [4,5]</td>
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<td>28/00</td>
<td>Coating for obtaining at least two superposed coatings either by methods not provided for in a single one of main groups C23C 2/00 to C23C 26/00, or by combinations of methods provided for in subclasses C23C and C25C or C25D [4]</td>
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<tr>
<td>28/02</td>
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**1/00**  
**Melting or fritting the enamels; Apparatus or furnaces therefor**

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<td>Melting or fritting the enamels; Apparatus or furnaces therefor</td>
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<td>1/02</td>
<td>Granulating the melt; Drying the granules</td>
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**Coating with the enamels**

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<td>Chemical treatment of the metal surfaces prior to coating (cleaning or de-greasing of metallic objects C23G)</td>
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<tr>
<td>7/00</td>
<td>Treating the coatings, e.g. drying before burning</td>
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</tbody>
</table>
C23F  NON-MECHANICAL REMOVAL OF METALLIC MATERIAL FROM SURFACES  (working of metal by electro-erosion B23H; desurfacing by applying flames B23K 7/00; working metal by laser beam B23K 26/00; producing decorative effects by removing surface-material, e.g. by engraving, by etching, B44C 1/22; electrolytic etching or polishing C25F); INHIBITING CORROSION OF METALLIC MATERIAL; INHIBITING INCRUSTATION IN GENERAL; MULTI-STEP PROCESSES FOR SURFACE TREATMENT OF METALLIC MATERIAL INVOLVING AT LEAST ONE PROCESS PROVIDED FOR IN CLASS C23 AND AT LEAST ONE PROCESS COVERED BY SUBCLASS C21D OR C22F OR CLASS C25 (inhibition or prevention of corrosion or incrustation during processing of hydrocarbons C10G 7/10, C10G 9/16, C10G 75/00) [4]

Notes
(1) This subclass covers inhibiting corrosion or incrustation in general, whether of or on metallic or non-metallic surfaces, subject to Note (2) below.
(2) This subclass does not cover:
   – protective layers or coating compositions or methods of applying them; these are classified in the appropriate places, e.g. B05, B44, C09D, C10M, C23C;
   – mechanical devices or constructional features of particular articles for inhibiting incrustation; these are classified in the appropriate places, e.g. in pipes or pipe fittings F16L 58/00;
   – articles characterised by being made of materials selected for their properties of resistance to corrosion or incrustation; these are classified in the appropriate places, e.g. turbine blades F01D 5/28.
(3) Processes using enzymes or micro-organisms in order to:
(i) liberate, separate or purify a pre-existing compound or composition, or to
(ii) treat textiles or clean solid surfaces of materials
are further classified in subclass C12S. [5]

Subclass Index
ETCHING, BRIGHTENING, COMPOSITIONS THEREFOR ........................................ 1/00, 3/00
OTHER REMOVING OF METALLIC MATERIAL ......................................................... 4/00
MULTI-STEP SURFACE TREATMENTS ...................................................... 17/00
INHIBITING CORROSION OR INCRUSTATION ............................................. 11/00 to 15/00

1/00  Etching metallic material by chemical means
(manufacture of printing surfaces B41C; manufacture of printed circuits H05K) [2]
   1/02  .  Local etching
   1/04  .  Chemical milling
   1/06  .  Sharpening files
   1/08  .  Apparatus, e.g. for photomechanical printing surfaces (photomechanical reproduction G03F)
   1/10  .  Etching compositions (C23F 1/44 takes precedence) [4]
   1/16  .  Acidic compositions (C23F 1/42 takes precedence) [4]
   1/18  .  for etching copper or alloys thereof [4]
   1/20  .  for etching aluminium or alloys thereof [4]
   1/22  .  for etching magnesium or alloys thereof [4]
   1/24  .  for etching silicon or germanium [4]
   1/26  .  for etching refractory metals [4]
   1/28  .  for etching iron group metals [4]
   1/30  .  for etching other metallic material [4]
   1/32  .  .  Alkaline compositions (C23F 1/42 takes precedence) [4]
   1/34  .  .  for etching copper or alloys thereof [4]
   1/36  .  .  for etching aluminium or alloys thereof [4]
   1/38  .  .  for etching refractory metals [4]
   1/40  .  .  for etching other metallic material [4]
   1/42  .  .  containing a dispersed water-immiscible liquid [4]
   1/44  .  .  Compositions for etching metallic material from a metallic material substrate of different composition [4]

3/00  Brightening metals by chemical means [2]
   3/02  .  Light metals
   3/03  .  .  with acidic solutions [4]
   3/04  .  Heavy metals
   3/06  .  .  with acidic solutions [4]
Inhibiting corrosion of metallic material by applying inhibitors to the surface in danger of corrosion or adding them to the corrosive agent (compositions for in situ inhibition of corrosion in boreholes or wells C09K 8/54; adding inhibitors to mineral oils, fuels or lubricants C10; adding inhibitors to pickling solutions C23G)

11/02 . in air or gases by adding vapour phase inhibitors
11/04 . in markedly acid liquids
11/06 . in markedly alkaline liquids
11/08 . in other liquids
11/10 . using organic inhibitors

Note
In groups C23F 11/12 to C23F 11/173 in the absence of an indication to the contrary, a compound is classified in the last appropriate place.

11/12 . . . Oxygen-containing compounds
11/14 . . . Nitrogen-containing compounds
11/16 . . . Sulfur-containing compounds
11/18 . . . using inorganic inhibitors

C23G CLEANING OR DE-GREASING OF METALLIC MATERIAL BY CHEMICAL METHODS OTHER THAN ELECTROLYSIS (polishing compositions C09G; detergents in general C11D)

Note
Processes using enzymes or micro-organisms in order to:
(i) liberate, separate or purify a pre-existing compound or composition, or to
(ii) treat textiles or clean solid surfaces of materials
are further classified in subclass C12S. [5]

1/00 Cleaning or pickling metallic material with solutions or molten salts (with organic solvents C23G 5/02)
1/02 . with acid solutions
1/04 . . using inhibitors
1/06 . . . organic inhibitors
1/08 . . . Iron or steel
1/10 . . . Other heavy metals
1/12 . . . Light metals
1/14 . . . with alkaline solutions
1/16 . . . using inhibitors
1/18 . . . Organic inhibitors
1/19 . . . Iron or steel [4]
1/20 . . . Other heavy metals [4]
1/22 . . . Light metals
1/24 . . . with neutral solutions
1/26 . . . using inhibitors
1/28 . . . with molten salts
1/30 . . . using inhibitors

1/32 . . Heavy metals
1/34 . . Light metals
1/36 . . Regeneration of waste pickling liquors

3/00 Apparatus for cleaning or pickling metallic material (with organic solvents C23G 5/04)
3/02 . for cleaning wires, strips, filaments continuously
3/04 . for cleaning pipes

5/00 Cleaning or de-greasing metallic material by other methods. Apparatus for cleaning or de-greasing metallic material with organic solvents

Note
In groups C23G 5/02 to C23G 5/06, in the absence of an indication to the contrary, classification is made in the last appropriate place. [4]
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